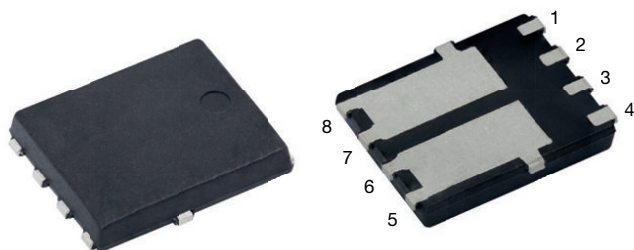


Hyperfast Rectifier, 2 x 3 A FRED Pt®



FlatPAK 5 x 6

1, 2 ○ —▶—○ 7, 8

3, 4 ○ —▶—○ 5, 6

FEATURES

- Hyperfast recovery time, reduced Q_{rr} , and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- AEC-Q101 qualified
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS

| | |
|-----------------------|-------------------|
| Package | FlatPAK 5 x 6 |
| $I_{F(AV)}$ | 2 x 3 A |
| V_R | 200 V |
| V_F at I_F | 0.71 V |
| t_{rr} (typ.) | 25 ns |
| T_J max. | 175 °C |
| Circuit configuration | Separated cathode |

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, piezo-injection, as high frequency rectifiers, and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

MECHANICAL DATA

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating
Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|----------------|---|-------------|-------|
| Peak repetitive reverse voltage | V_{RRM} | | 200 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_{Solderpad} = 170\text{ °C}$, DC | 6 | A |
| | | $T_{Solderpad} = 169\text{ °C}$, D = 0.5 | | |
| Non-repetitive peak surge current | I_{FSM} | $T_J = 25\text{ °C}$, 10 ms sinusoidal pulse | 173 | |
| | | | 87 | |
| Operating junction and storage temperatures | T_J, T_{Stg} | | -55 to +175 | °C |

**ELECTRICAL SPECIFICATIONS** ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------------------|---------------|---|------|------|------|---------------|
| Breakdown voltage, blocking voltage | V_{BR}, V_R | $I_R = 100\text{ }\mu\text{A}$ | 200 | - | - | V |
| Forward voltage, per diode | V_F | $I_F = 3\text{ A}$ | - | 0.88 | 0.94 | |
| | | $I_F = 3\text{ A}, T_J = 150\text{ }^{\circ}\text{C}$ | - | 0.71 | 0.74 | |
| Reverse leakage current, per diode | I_R | $V_R = V_R\text{ rated}$ | - | - | 2 | μA |
| | | $T_J = 150\text{ }^{\circ}\text{C}, V_R = V_R\text{ rated}$ | - | 2 | 40 | |
| Junction capacitance | C_T | $V_R = 200\text{ V}$ | - | 14 | - | pF |

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------|-----------|--|------|------|------|-------|
| Reverse recovery time | t_{rr} | $I_F = 1.0\text{ A}, dI_F/dt = 50\text{ A}/\mu\text{s}, V_R = 30\text{ V}$ | - | 20 | - | ns |
| | | $I_F = 0.5\text{ A}, I_R = 1\text{ A}, I_{rr} = 0.25\text{ A}$ | - | - | 25 | |
| | | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 15 | - | |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 25 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 2 | - | A |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 3 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^{\circ}\text{C}$ | - | 12 | - | nC |
| | | $T_J = 125\text{ }^{\circ}\text{C}$ | - | 40 | - | |

THERMAL - MECHANICAL SPECIFICATIONS

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|--|---------------------|-----------------|------|------|------|-----------------------------|
| Maximum junction and storage temperature range | T_J, T_{Stg} | | -55 | - | 175 | $^{\circ}\text{C}$ |
| Thermal resistance, junction to ambient, per diode | $R_{thJA}^{(1)(2)}$ | | - | 90 | 103 | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance, junction to mount, per diode | $R_{thJM}^{(3)}$ | | - | 2.3 | 2.6 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{thJA}$
(2) Free air, mounted or recommended copper pad area; thermal resistance R_{thJA} - junction to ambient
(3) Mounted on infinite heatsink

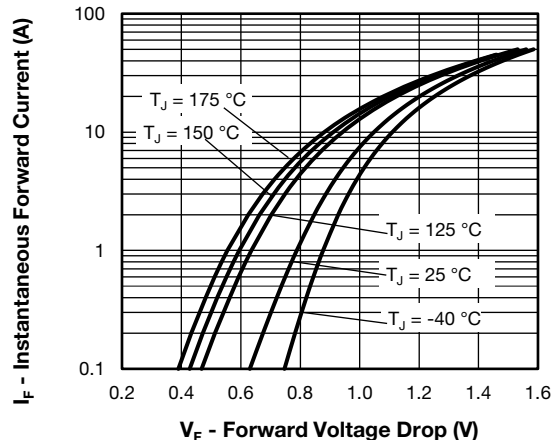


Fig. 1 - Typical Forward Voltage Drop Characteristics

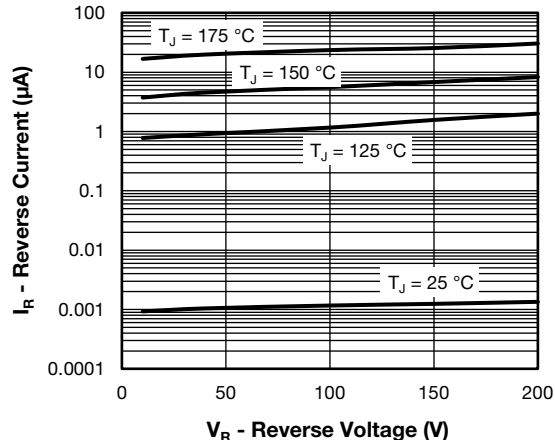


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

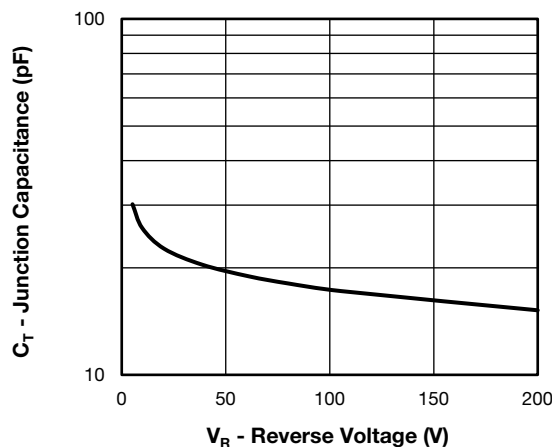
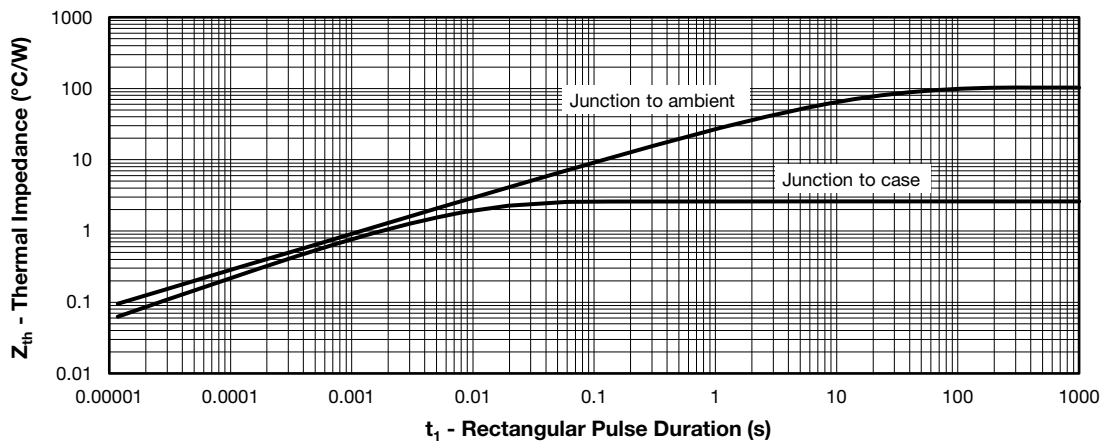


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

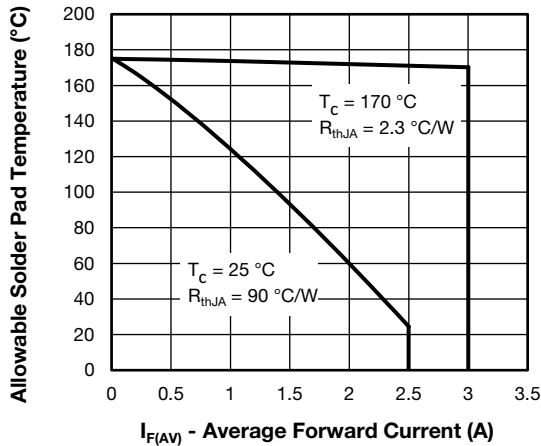


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

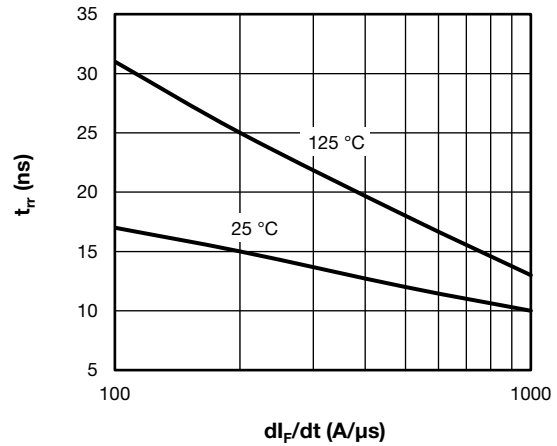


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

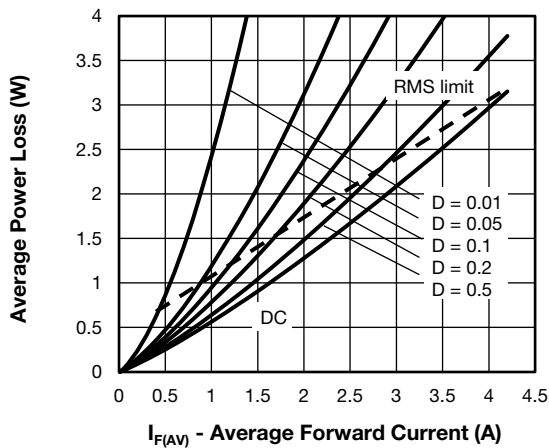


Fig. 6 - Forward Power Loss Characteristics

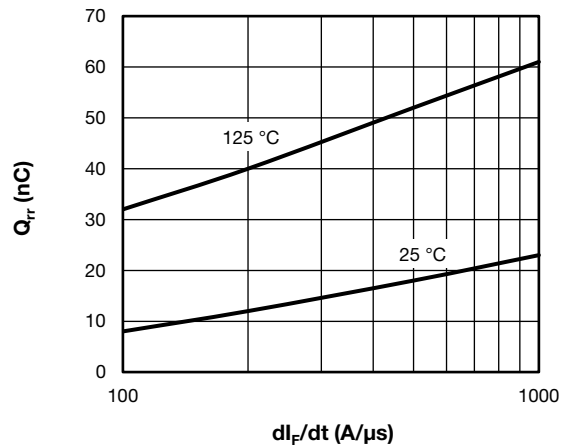


Fig. 8 - Typical Stored Charge vs. dI_F/dt

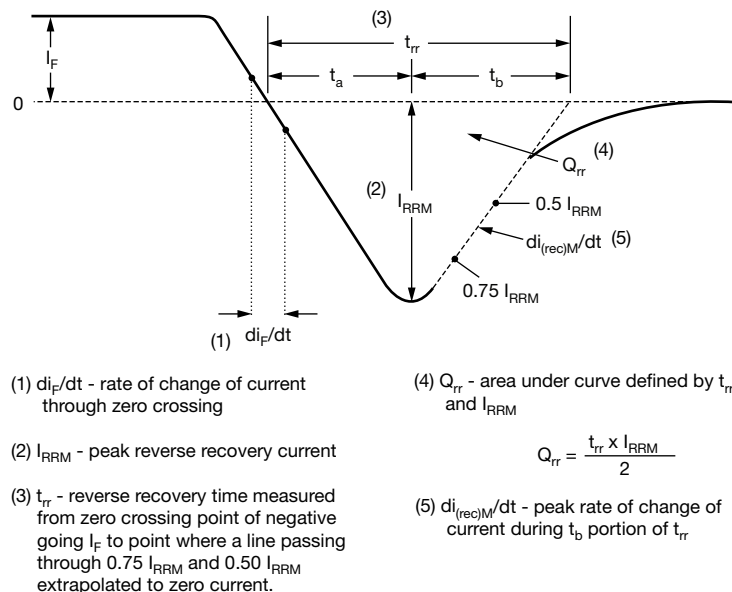


Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

| | | | | | | | | |
|-------------|--|---|---|---|---|----|---|----|
| Device code | VS- | 6 | D | K | H | 02 | H | M3 |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
| 1 | - Vishay Semiconductors product | | | | | | | |
| 2 | - Current rating (6 = 6 A) | | | | | | | |
| 3 | - Circuit configuration: D = separated cathode | | | | | | | |
| 4 | - K = FlatPAK package | | | | | | | |
| 5 | - Process type, H = hyperfast recovery | | | | | | | |
| 6 | - Voltage code (02 = 200 V) | | | | | | | |
| 7 | - H = AEC-Q101 qualified | | | | | | | |
| 8 | - M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free | | | | | | | |

ORDERING INFORMATION (example)

| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | PACKAGING DESCRIPTION |
|----------------|-----------------|------------------------|---------------|-----------------------------------|
| VS-6DKH02HM3/H | 0.10 | H | 1500 | 7" diameter plastic tape and reel |

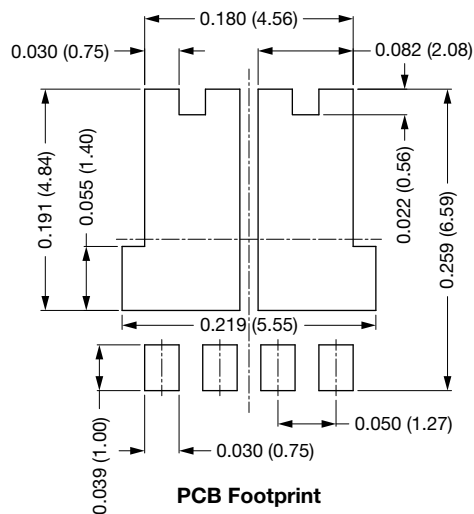
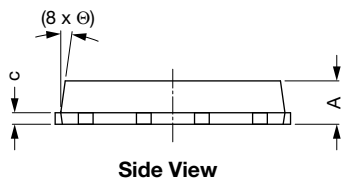
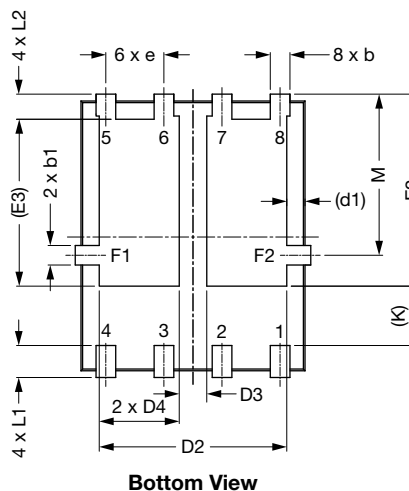
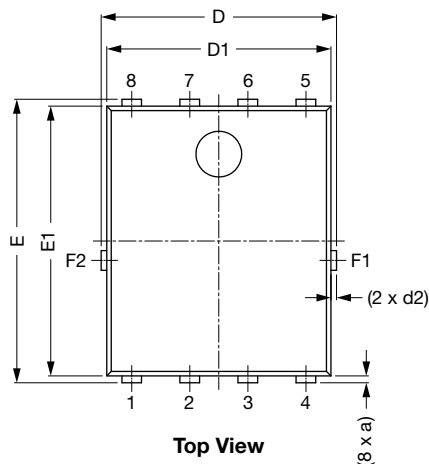
LINKS TO RELATED DOCUMENTS

| | |
|--------------------------|--|
| Dimensions | www.vishay.com/doc?96056 |
| Part marking information | www.vishay.com/doc?96059 |
| Packaging information | www.vishay.com/doc?88869 |
| SPICE model | www.vishay.com/doc?96882 |



FlatPAK 5 x 6 (Dual)

DIMENSIONS in inches (millimeters)



| DIM. | INCHES | | | MILLIMETERS | | |
|------|--------|-------|-------|-------------|-------|------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.035 | 0.039 | 0.043 | 0.89 | 0.99 | 1.09 |
| (a) | - | 0.006 | - | - | 0.15 | - |
| b | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| b1 | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| c | 0.008 | - | 0.014 | 0.20 | - | 0.35 |
| D | 0.197 | 0.203 | 0.209 | 5.00 | 5.15 | 5.30 |
| D1 | 0.189 | 0.193 | 0.197 | 4.80 | 4.90 | 5.00 |
| D2 | 0.154 | 0.161 | 0.169 | 3.90 | 4.10 | 4.30 |
| D3 | 0.020 | 0.024 | 0.031 | 0.50 | 0.60 | 0.80 |
| D4 | 0.063 | 0.069 | 0.075 | 1.60 | 1.75 | 1.90 |
| (d1) | - | 0.016 | - | - | 0.40 | - |
| (d2) | - | 0.005 | - | - | 0.125 | - |
| E | 0.238 | 0.244 | 0.250 | 6.05 | 6.20 | 6.35 |



| DIM. | INCHES | | | MILLIMETERS | | |
|------|-----------|-------|-------|-------------|------|------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| E1 | 0.228 | 0.232 | 0.236 | 5.80 | 5.90 | 6.00 |
| E2 | 0.157 | 0.165 | 0.173 | 4.00 | 4.20 | 4.40 |
| (E3) | - | 0.144 | - | - | 3.65 | - |
| e | 0.050 BSC | | | 1.27 BSC | | |
| (K) | 0.039 | - | - | 1.00 | - | - |
| L1 | 0.019 | - | 0.043 | 0.48 | - | 1.10 |
| L2 | 0.012 | - | 0.031 | 0.30 | - | 0.80 |
| M | 0.128 | 0.138 | 0.148 | 3.25 | 3.50 | 3.75 |
| Θ | 0° | - | 10° | 0° | - | 10° |

Notes

- Dimensioning and tolerancing per ASME Y14.5-2009
- Dimensions D1 and E1 do not include mold flash or gate burrs
- Dimension (XX) means reference only



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